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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

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Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







IGBT - Inverter Welding

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss. The IGBT is well suited for welding applications. Incorporated into the device is a soft and fast co–packaged free wheeling diode with a low forward voltage.

Features

- $T_{Jmax} = 175^{\circ}C$
- Soft Fast Reverse Recovery Diode
- Optimized for High Speed Switching
- 5 µs Short–Circuit Capability
- These are Pb-Free Devices

Typical Applications

Welding

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit	
Collector-emitter voltage	V _{CES}	600	V	
Collector current @ Tc = 25°C @ Tc = 100°C	I _C	100 75	Α	
Diode Forward Current @ Tc = 25°C @ Tc = 100°C	l _F	100 75	Α	
Diode Pulsed Current T _{PULSE} Limited by T _J Max	I _{FM}	200	Α	
Pulsed collector current, T _{pulse} limited by T _{Jmax}	ІСМ	200	Α	
Short–circuit withstand time $V_{GE} = 15 \text{ V}, V_{CE} = 400 \text{ V}, $ $T_{J} \le +150 ^{\circ}\text{C}$	t _{SC}	5	μS	
Gate-emitter voltage	V_{GE}	±20	V	
Transient gate-emitter voltage (T _{PULSE} = 5 μ s, D < 0.10)		±30	V	
Power Dissipation @ Tc = 25°C @ Tc = 100°C	P _D	595 265	W	
Operating junction temperature range	TJ	–55 to +175	°C	
Storage temperature range	T _{stg}	-55 to +175	°C	
Lead temperature for soldering, 1/8" from case for 5 seconds	T _{SLD}	260	°C	

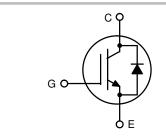
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

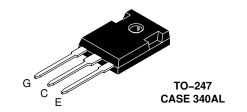


ON Semiconductor®

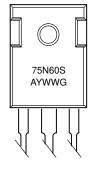
www.onsemi.com

75 A, 600 V V_{CEsat} = 1.70 V E_{OFF} = 1.0 mJ





MARKING DIAGRAM



A = Assembly Location

Y = Year WW = Work Week G = Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping
NGTB75N60SWG	TO-247 (Pb-Free)	30 Units / Rail

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ heta JC}$	0.28	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ heta JC}$	0.62	°C/W
Thermal resistance junction-to-ambient	$R_{ hetaJA}$	40	°C/W

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC						
Collector–emitter breakdown voltage, gate–emitter short–circuited	$V_{GE} = 0 \text{ V}, I_{C} = 500 \mu\text{A}$	V _{(BR)CES}	600	_	_	V
Collector-emitter saturation voltage	V _{GE} = 15 V, I _C = 75 A V _{GE} = 15 V, I _C = 75 A, T _J = 175°C	V _{CEsat}	1.50 -	1.70 1.85	2.00 -	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}$, $I_C = 350 \mu A$	$V_{GE(th)}$	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	V _{GE} = 0 V, V _{CE} = 600 V V _{GE} = 0 V, V _{CE} = 600 V, T _{J =} 175°C	I _{CES}	_ _	_ _	0.1 4.0	mA
Gate leakage current, collector-emitter short-circuited	V _{GE} = 20 V , V _{CE} = 0 V	I _{GES}	_	-	200	nA
DYNAMIC CHARACTERISTIC						
Input capacitance		C _{ies}	-	7500	_	pF
Output capacitance	$V_{CE} = 20 \text{ V}, V_{GE} = 0 \text{ V}, f = 1 \text{ MHz}$	C _{oes}	-	300	-	1
Reverse transfer capacitance	1	C _{res}	-	190	_	1
Gate charge total		Qg	-	310	-	nC
Gate to emitter charge	$V_{CE} = 480 \text{ V}, I_{C} = 75 \text{ A}, V_{GE} = 15 \text{ V}$	Q _{ge}	_	60	_	
Gate to collector charge		Q_{gc}	ı	150	_	
SWITCHING CHARACTERISTIC, INDUC	TIVE LOAD					
Turn-on delay time		t _{d(on)}	-	110	_	ns
Rise time	1	t _r	-	48	-	
Turn-off delay time	T _J = 25°C	t _{d(off)}	-	270	-	1
Fall time	$V_{CC} = 400 \text{ V}, I_{C} = 75 \text{ A}$ $R_{q} = 10 \Omega$	t _f	-	70	-	1
Turn-on switching loss	$V_{GE} = 0 \text{ V} / 15 \text{ V}$	E _{on}	_	1.5	_	mJ
Turn-off switching loss	1	E _{off}	_	1.0	_	1
Total switching loss	1	E _{ts}	_	2.5	-	1
Turn-on delay time		t _{d(on)}	-	100	_	ns
Rise time	1	t _r	-	50	_	
Turn-off delay time	$T_{J} = 150^{\circ}\text{C}$ $V_{CC} = 400 \text{ V, } I_{C} = 75 \text{ A}$ $R_{g} = 10 \Omega$ $V_{GE} = 0 \text{ V/ } 15 \text{ V}$	t _{d(off)}	-	280	_	
Fall time		t _f	_	100	_	
Turn-on switching loss		E _{on}	_	1.9	_	mJ
Turn-off switching loss		E _{off}	-	1.8	_]
Total switching loss		E _{ts}	-	3.7	_	
DIODE CHARACTERISTIC						
Forward voltage	$V_{GE} = 0 \text{ V, } I_F = 75 \text{ A}$ $V_{GE} = 0 \text{ V, } I_F = 50 \text{ A, } T_J = 175^{\circ}\text{C}$	V _F	1.70 –	2.20 2.40	2.90 -	V
Reverse recovery time	T _J = 25°C	t _{rr}	_	80	_	ns
Reverse recovery charge	$I_F = 75 \text{ A}, V_R = 200 \text{ V}$	Q _{rr}	_	0.40	_	μС
Reverse recovery current	$di_F/dt = 200 A/\mu s$	I _{rrm}	_	8	_	Α

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS

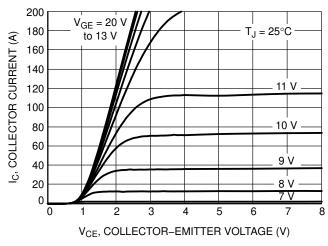


Figure 1. Output Characteristics

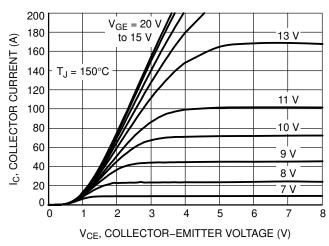


Figure 2. Output Characteristics

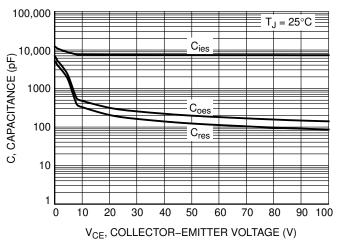


Figure 3. Typical Capacitance

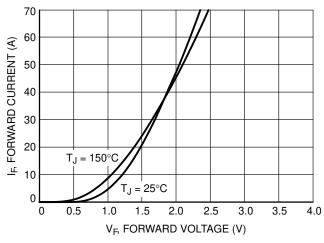


Figure 4. Diode Forward Characteristics

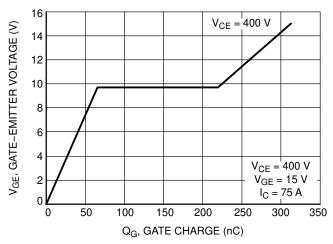


Figure 5. Typical Gate Charge

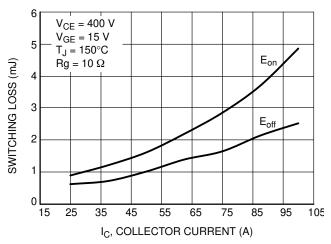


Figure 6. Switching Loss vs. I_C

TYPICAL CHARACTERISTICS

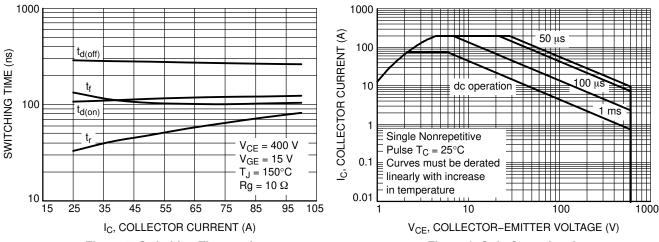


Figure 7. Switching Time vs. I_C

Figure 8. Safe Operating Area

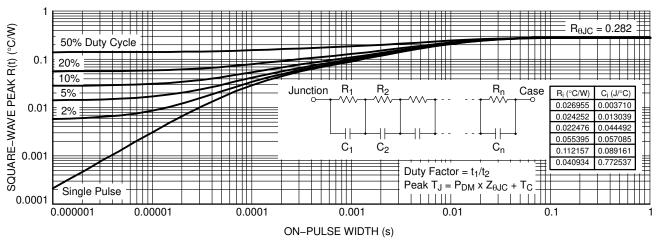


Figure 9. IGBT Transient Thermal Impedance

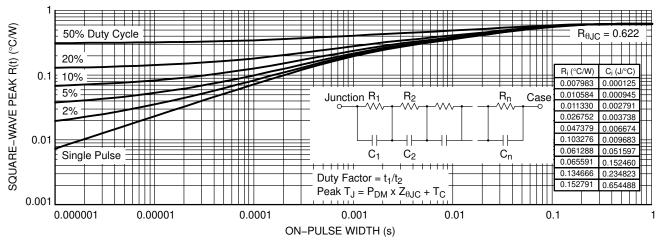
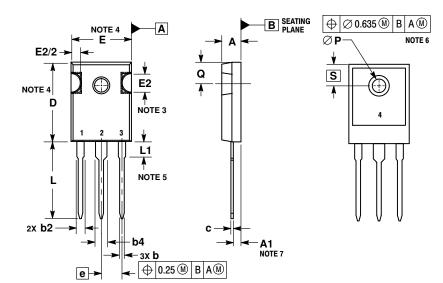


Figure 10. Diode Transient Thermal Impedance

PACKAGE DIMENSIONS

TO-247 CASE 340AL **ISSUE A**



NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 CONTROLLING DIMENSION: MILLIMETERS.

- SLOT REQUIRED, NOTCH MAY BE ROUNDED.
 DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.13 PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREME OF THE PLASTIC BODY.
- LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY
- ØP SHALL HAVE A MAXIMUM DRAFT ANGLE OF 1.5° TO THE TOP OF THE PART WITH A MAXIMUM DIAMETER OF 3.91.
- DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.

	MILLIMETERS		
DIM	MIN	MAX	
Α	4.70	5.30	
A1	2.20	2.60	
b	1.00	1.40	
b2	1.65	2.35	
b4	2.60	3.40	
С	0.40	0.80	
D	20.30	21.40	
Е	15.50	16.25	
E2	4.32	5.49	
е	5.45 BSC		
L	19.80	20.80	
L1	3.50	4.50	
P	3.55	3.65	
Q	5.40	6.20	
S	6.15 BSC		

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